

0.5A TRENCH SBR TRENCH SUPER BARRIER RECTIFIER

Product Summary (@ T_A = +25°C)

V _{RRM} (V)	I _O (A)	V _F Max (V)	I _R Max (mA)
20	0.5	0.39	0.05

Features and Benefits

- Ultra-Low Forward Voltage Drop
- Superior Reverse Avalanche Capability
- Patented SBR® (Super Barrier Rectifier) Technology
- Soft, Fast Switching Capability
- +150°C Operating Junction Temperature
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Description and Applications

Packaged in the compact X2-DFN1006-2, the Trench SBR, the SBRT05U20LPS provides ultra-low forward voltage drop (V_F) and excellent low reverse leakage stability at high temperatures. It is ideal for use in rectification, freewheeling or polarity protection for applications such as:

- SMPS
- General Switching Applications
- Reverse Polarity Protection
- DC-DC Converters

Mechanical Data

- Case: X2-DFN1006-2
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Dot
- Terminals: Finish NiPdAu over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 [™]
- Weight: 0.001 grams (Approximate)

X2-DFN1006-2



Bottom View

Ordering Information (Note 4)

Part Number	Case	Packaging
SBRT05U20LPS-7	X2-DFN1006-2	3000/Tape & Reel
SBRT05U20LPS-7B	X2-DFN1006-2	10000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

X2-DFN1006-2



V2 = Product Type Marking Code



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _{RM}	20	V
RMS Reverse Voltage	V _{R(RMS)}	14	V
Average Rectified Output Current (See Figure 4)	Io	500	mA
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	10	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Ambient (Note 5)	$R_{\theta JA}$	236	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

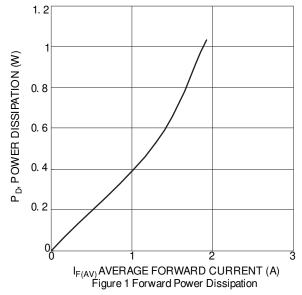
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage Drop	V _F	111	0.28 0.30 0.35	0.32 0.34 0.39	V	$\begin{split} I_F &= 0.1 \text{A, } T_J = +25^{\circ}\text{C} \\ I_F &= 0.2 \text{A, } T_J = +25^{\circ}\text{C} \\ I_F &= 0.5 \text{A, } T_J = +25^{\circ}\text{C} \end{split}$
Leakage Current (Note 6)	I _R	_	11 2.5	50 10		$V_R = 20V, T_J = +25^{\circ}C$ $V_R = 20V, T_J = +125^{\circ}C$
Total Capacitance	C _T	1	14	_	pF	f = 1MHz, V _R = 20V

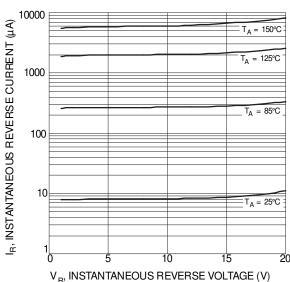
Notes:

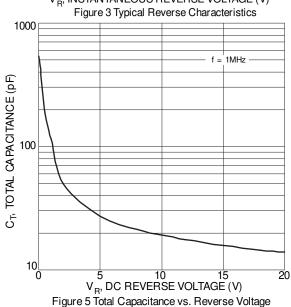
^{5.} Device mounted on 1*MRP FR-4 PC board, 2oz.

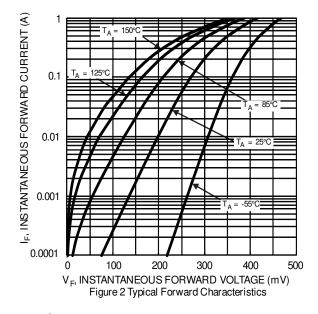
^{6.} Short duration pulse test used to minimize self-heating effect.

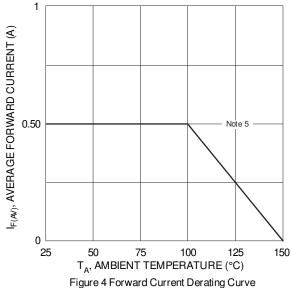










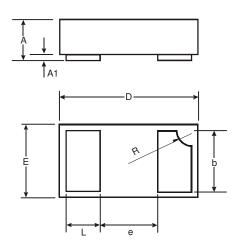




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-DFN1006-2

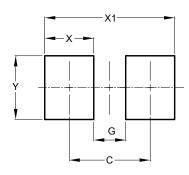


X2-DFN1006-2					
Dim	Min	Max	Тур		
Α	0.34	0.4	0.37		
A1	0	0.05	0.03		
b	0.45	0.55	0.50		
D	0.95	1.075	1.00		
Е	0.55	0.675	0.60		
е	-	1	0.40		
L	0.20	0.30	0.25		
R	0.05	0.15	0.10		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-DFN1006-2



Dimensions	Value (in mm)	
С	0.70	
G	0.30	
Х	0.40	
X1	1.10	
Υ	0.70	



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